



Information & Control NA TC Chapter

NA Fall 2019 Meetings

Wednesday, November 6

Milpitas, CA

08:00 AM – 02:00 PM

AGENDA

	Time
1 Welcome/Call to Order	08:00-08:15
1.1 Introductions	
1.2 Required Elements (Membership Requirements, Antitrust and Intellectual Property Reminders, and Effective Meeting Guidelines)	
1.3 Agenda Review	
2 Review of Previous Meeting Minutes (including open Action Items review)	08:15-08:20
3 Staff Report	08:20-08:25
4 Liaison Reports	08:25-09:00
4.1 Europe TC Chapter	
4.2 Japan TC Chapter	
4.3 Korea TC Chapter	
4.4 Taiwan TC Chapter	

5 Ballot Review (including safety and IP checks) and motion to forward to A&R **9:00-11:45**

#	When	TF	Details
R6348B	Cycle 7-2019	GEM300 TF	Revision to E30-0418, <i>Specification for the Generic Model for Communications and Control of Manufacturing Equipment (GEM)</i> Ratification Ballot
6346A	Cycle 7-2019	DDA TF	Revision to Add a New Subordinate Standard: <i>Specification for Protocol Buffers for Equipment Client Authentication and Authorization (ECA)</i> to SEMI E132-1015, <i>Specification for Equipment Client Authentication and Authorization</i>
6344A	Cycle 7-2019	DDA TF	New Standard: <i>Specification for Protocol Buffers Semiconductor Common Components</i>
6527	Cycle 7-2019	DDA TF	Revision to SEMI E125-0414, <i>Specification for Equipment Self Description (EqSD)</i>
6571	Cycle 7-2019	DDA TF	Revision to SEMI E132-0419: <i>Specification for Equipment Client Authentication and Authorization</i>
6553	Cycle 7-2019	DDA TF	Revision to SEMI E134-MMY: <i>Specification for Data Collection Management</i>



6563	Cycle 7-2019	SB TF	Reapproval to SEMI E54.18-0914: <i>Specification for Sensor/Actuator Network Specific Device Model for Vacuum Pump Device</i>
6564	Cycle 7-2019	SB TF	Reapproval to SEMI E54.22-0914: <i>Specification for Sensor/Actuator Network Specific Device Model for Vacuum Pressure Gauges</i>
6562	Cycle 7-2019	SB TF	Line-item Revision to SEMI E54.23, Specification for Sensor/Actuator Network Communications for CC-Link IE Field Network

6 Lunch Break 11:45-12:15

7 Subcommittee & Task Force Reports (including leadership and TF changes) 12:15-13:15

- 7.1 GEM300 Task Force
- 7.2 Diagnostic Data Acquisition (DDA) Task Force
- 7.3 Sensor Bus (SB) Task Force
- 7.4 Process Control Systems (PCS) Task Force
- 7.5 Energy Saving Equipment Communication (ESEC) Task Force
- 7.6 Fab & Equipment Computer and Device Security (CDS) Task Force
- 7.7 Advanced Backend Factory Integration (ABFI) Task Force
- 7.8 GUI Task Force <tentative>

8 Old Business 13:15-13:30

- 8.1 North America I&C Standards due for 5-Year
- 8.2 SNARFs past Three-Year Document Development Project Period
- 8.3 SNARF to retire due to the scope change

9 New Business 13:30-13:50

- 9.1 New TFOFs & SNARFs
- 9.2 New Ballot(s) Submission Summary
- 9.3 APC/SEMI Smart Manufacturing Update – James Moyne (AMAT/UMICH)

10 New Action Items Review 13:50-13:55

Next Meeting Spring 2020 Meetings <tentative> 13:55-14:00

Monday, March 30, 2020, SEMI HQ, Milpitas CA

- North America I&C Leadership (12:00 Noon – 1:00 PM)
- I&C GCS (1:00 PM – 1:30 PM)
- GEM300 TF (1:30 PM – 4:00 PM)
- PCS TF (4:00 PM – 5:00 PM)
- Sensor Bus (SB) TF (5:00 PM – 6:00 PM)
- Advanced Backend Factory Integration (ABFI) TF (4:00 PM – 6:00 PM)



Tuesday, March 31, 2020, SEMI HQ, Milpitas CA

- I&C GUI TF (8:00 AM – 9:00 AM)
- Energy Saving Equipment Communication (ESEC) TF (9:00 AM – 10:30 AM)
- Fab & Equipment Computer and Device Security (CDS) TF (10:30 AM – 1:00 PM)
- DDA TF (1:00 PM – 6:00 PM)

Wednesday, April 1, 2020, SEMI HQ, Milpitas CA

- I&C Committee (8:00 AM – 2:00 PM)

11 Adjournment

14:00

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